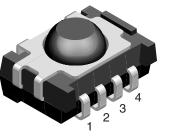
IR Receiver Modules for Remote Control Systems



16797

MECHANICAL DATA

Pinning 1 = GND, 2 = N.C., 3 = V_S, 4 = OUT

ORDERING CODE

Taping: TSOP6...TT - top view taped TSOP6...TR - side view taped

FEATURES

- Low supply current
- · Photo detector and preamplifier in one package
- Internal filter for PCM frequency
- Improved shielding against EMI
- Supply voltage: 2.5 V to 5.5 V
- · Improved immunity against ambient light
- · Insensitive to supply voltage ripple and noise
- GREEN Taping available for top view and side view (5-2008) assembly
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

The TSOP61..., TSOP63.. series are miniaturized SMD-IR receivers for infrared remote control systems. A PIN diode and a preamplifier are assembled on a lead frame, the epoxy package acts as an IR filter.

The demodulated output signal can be directly connected to a microprocessor for decoding. The TSOP61.. is a legacy product compatible with all common IR remote control data formats. The TSOP63.. is optimized to better suppress spurious pulses from energy saving fluorescent lamps. The TSOP65.. has an excellent noise suppression. It is immune to dimmed LCD backlighting and any fluorescent lamps. AGC3 and AGC5 may also suppress some data signals in case of continuous transmission. Between these three receiver types, the TSOP63.. is preferred. Customers should initially try the TSOP63.. in their design.

This component has not been gualified according to automotive specifications.

PARTS T	ABLE			
AGC		LEGACY, FOR SHORT BURST REMOTE CONTROLS (AGC1)	NOISY ENVIRONMENTS AND SHORT BURSTS (AGC3)	VERY NOISY ENVIRONMENTS AND SHORT BURSTS (AGC5)
	30 kHz	TSOP6130	TSOP6330	TSOP6530
	33 kHz	TSOP6133	TSOP6333	TSOP6533
Carrier	36 kHz	TSOP6136	TSOP6336 ⁽¹⁾⁽²⁾	TSOP6536 ⁽¹⁾⁽²⁾
frequency	38 kHz	TSOP6138	TSOP6338 (3)(4)(5)(6)	TSOP6538 ⁽³⁾⁽⁴⁾⁽⁵⁾
	40 kHz	TSOP6140	TSOP6340	TSOP6540
	56 kHz	TSOP6156	TSOP6356	TSOP6556
Package			Panhead	
Pinning			$1 = GND, 2 = N.C., 3 = V_S, 4 = OUT$	
Dimensions	s (mm)		7.5 W x 5.3 H x 4.0 D	
Mounting			SMD	
Application			Remote control	
Best remote	e control code	⁽¹⁾ MCIR ⁽²⁾ RCMM ⁽³⁾) Mitsubishi ⁽⁴⁾ RECS-80 Code ⁽⁵⁾ r-m	nap ⁽⁶⁾ XMP-1, XMP-2

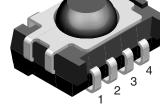
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1

RoHS

COMPLIANT

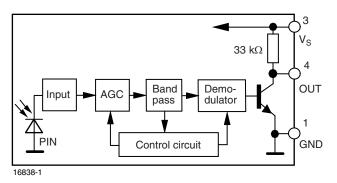
HALOGEN FREE



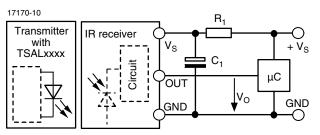
www.vishay.com



BLOCK DIAGRAM



APPLICATION CIRCUIT



The external components R₁ and C₁ are optional to improve the robustness against electrical overstress (typical values are R₁ = 100 Ω , C₁ = 0.1 μ F).

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
Supply voltage		V _S	-0.3 to +6	V		
Supply current		ا _S	5	mA		
Output voltage		Vo	-0.3 to (V _S + 0.3)	V		
Output current		Ι _Ο	5	mA		
Junction temperature		Tj	100	°C		
Storage temperature range		T _{stg}	-25 to +85	°C		
Operating temperature range		T _{amb}	-25 to +85	°C		
Power consumption	$T_{amb} \le 85 \ ^{\circ}C$	P _{tot}	10	mW		

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability.

ELECTRICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.5		5.5	V
Supply ourrent	$V_{\rm S} = 5 V, E_{\rm v} = 0$	I _{SD}	0.55	0.7	0.9	mA
Supply current	$E_v = 40$ klx, sunlight	I _{SH}		0.8		mA
Transmission distance	$E_v = 0$, IR diode TSAL6200, I _F = 250 mA, test signal see fig. 1	d		40		m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2$, test signal see fig. 1	V _{OSL}			100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see fig. 1	E _{e min.}		0.2	0.4	mW/m ²
Maximum irradiance	t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see fig. 1	E _{e max.}	50			W/m ²
Directivity	Angle of half transmission distance	φ1/2		± 50		deg

TSOP61.., TSOP63.., TSOP65..



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TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

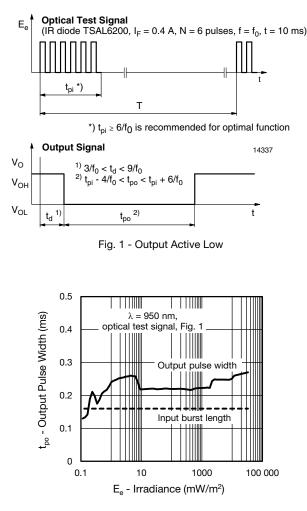
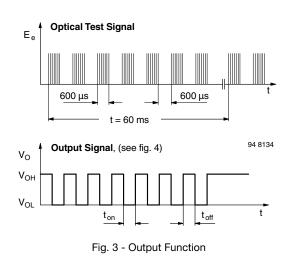


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient



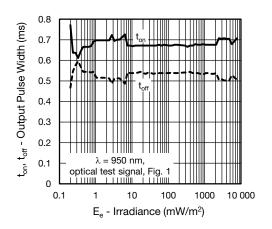


Fig. 4 - Output Pulse Diagram

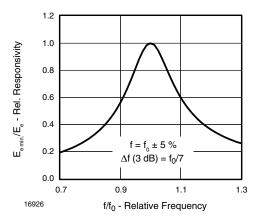


Fig. 5 - Frequency Dependence of Responsivity

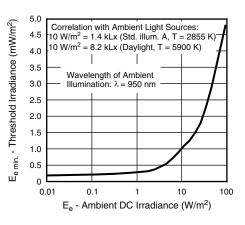


Fig. 6 - Sensitivity in Bright Ambient

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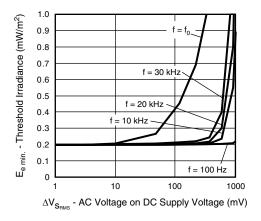


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

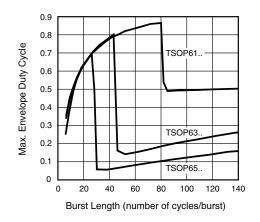


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

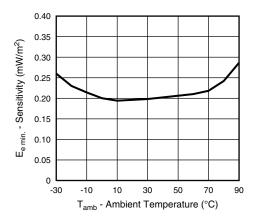


Fig. 9 - Sensitivity vs. Ambient Temperature

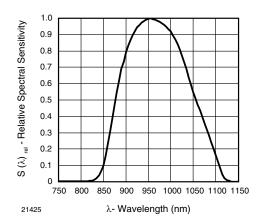


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength

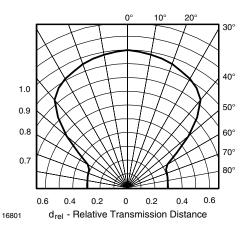


Fig. 11 - Horizontal Directivity

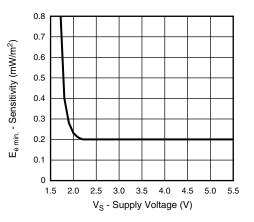


Fig. 12 - Sensitivity vs. Supply Voltage

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TSOP61.., TSOP63.., TSOP65..

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SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output.

Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- Continuous signals at any frequency
- Strongly or weakly modulated patterns from fluorescent lamps with electronic ballasts (see figure 13 or figure 14)

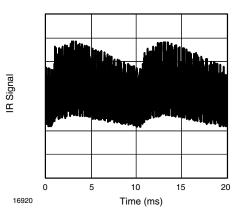


Fig. 13 - IR Disturbance from Fluorescent Lamp with Low Modulation

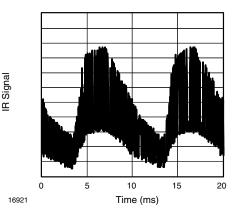


Fig. 14 - IR Disturbance from Fluorescent Lamp with High Modulation

	TSOP61	TSOP63	TSOP65
Minimum burst length	6 cycles/burst	6 cycles/burst	6 cycles/burst
After each burst of length A gap time is required of	6 to 70 cycles ≥ 10 cycles	6 to 35 cycles ≥ 10 cycles	6 to 24 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	70 cycles > 1.2 x burst length	35 cycles > 6 x burst length	24 cycles > 25 ms
Maximum number of continuous short bursts/second	2000	2000	2000
MCIR code	yes	preferred	yes
RCMM code	yes	preferred	yes
XMP-1, XMP-2 code	yes	preferred	yes
Suppression of interference from fluorescent lamps	Common disturbance patterns are supressed (example: signal pattern of fig. 14)	Even critical disturbance patterns are suppressed (examples: signal pattern of fig. 14 and fig. 15)	Even critical disturbance patterns are suppressed (examples: signal pattern of fig. 14 and fig. 15)

Notes

• For data formats with long bursts (more than 10 carrier cycles) please see the datasheet for TSOP62.., TSOP64..

- Best choice of AGC for some popular IR-codes:
 - TSOP6336, TSOP36536: MCIR, RCMM
 - TSOP6538: Mitsubishi, RECS-80 Code
 - TSOP6338: XMP-1, XMP-2, r-map
- For SIRCS 15 and 20 bit, Sony 12 bit IR-codes, please see the datasheet for TSOP4S40, TSOP2S40

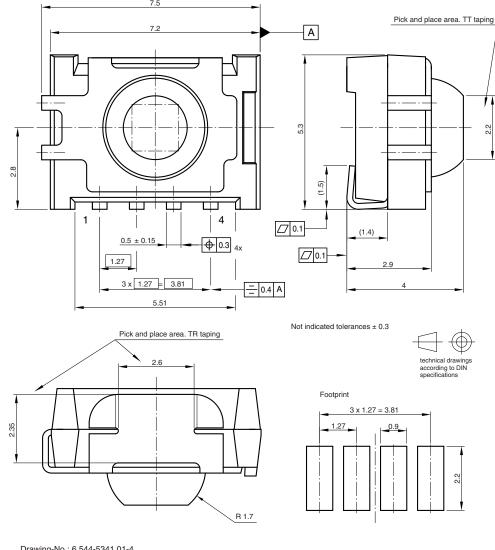
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TSOP61.., TSOP63.., TSOP65..

Vishay Semiconductors

PACKAGE DIMENSIONS in millimeters



Drawing-No.: 6.544-5341.01-4 Issue: 8; 02.09.09

ASSEMBLY INSTRUCTIONS

Reflow Soldering

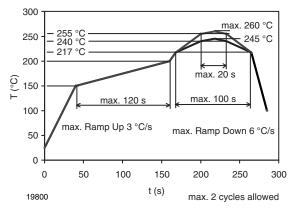
- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

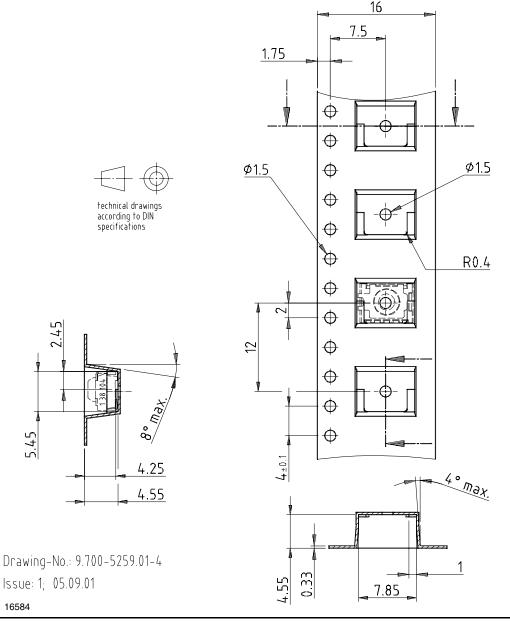
- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 $^\circ\mathrm{C}$
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off



VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TT DIMENSIONS in millimeters



Rev. 1.1, 06-Feb-14

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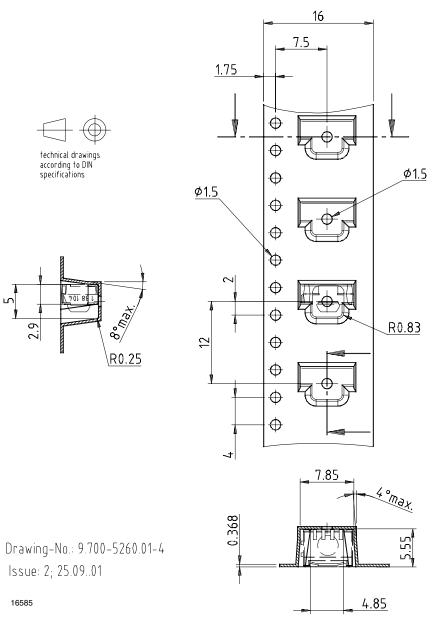
THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



TSOP61.., TSOP63.., TSOP65..

Vishay Semiconductors

TAPING VERSION TSOP..TR DIMENSIONS in millimeters

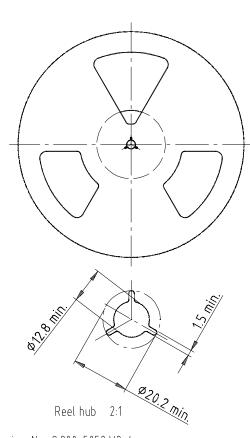


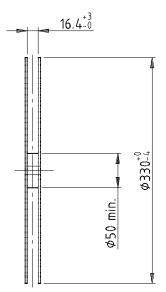


TSOP61.., TSOP63.., TSOP65..

Vishay Semiconductors

REEL DIMENSIONS in millimeters





Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286–3

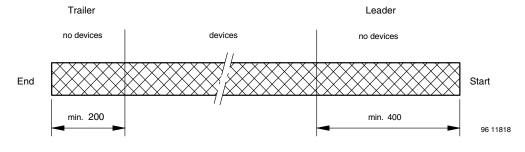
Tape width 16



technical drawings according to DIN specifications

Drawing-No.: 9.800-5052.V2-4 Issue: 1; 07.05.02

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

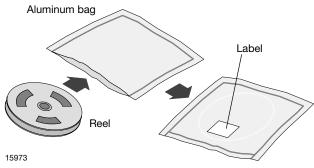
Rev. 1.1, 06-Feb-14



PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
LONG BAR CODE TOP	ТҮРЕ	LENGTH
Item-number	Ν	8
Plant-code	Ν	2
Sequence-number	Х	3
Quantity	Ν	8
Total length	-	21
SHORT BAR CODE BOTTOM	ТҮРЕ	LENGTH
Selection-code	X	3
Data-code	Ν	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOF OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

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After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air/nitrogen) or

96 h at 60 $^{\circ}\text{C}~$ + 5 $^{\circ}\text{C}$ and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

Document Number: 82457



ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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Tape and Reel Standards for SMD IR Receiver Modules

Vishay Semiconductor SMD IR Receivers are packaged on tape and reel. The following specification is based on IEC publication 286, which takes the industrial requirements for automatic insertion into account.

Absolute maximum ratings, mechanical dimensions, optical and electrical characteristics for taped devices are identical to the basic catalog types and can be found in the specifications for untaped devices.

PACKAGING

The tapes of components are available on reels. Each reel is marked with labels which contain the following information:

- Vishay
- Туре
- Group
- Tape code, normally part of type name
- Production code
- Quantity

MISSING COMPONENTS

Up to 3 consecutive components may be missing if the gap is followed by at least 6 components. A maximum of 0.5 % of the components per reel quantity may be missing. At least 5 empty positions are present at the start and the end of the tape to enable tape insertion.

Tensile strength of the tape: > 15 N

NUMBER OF COMPONENTS

- A. Panhead SMD: quantity per reel: TT, SMD top view package, 1190 pcs
 - TR, SMD side view package, 1120 pcs
- B. Heimdall: quantity per reel:
 TT, Heimdall top view package, 2200 pcs
 TR, Heimdall side view package, 2300 pcs
- C. Heimdall without lens: quantity per reel: WTT, top view package, 2200 pcs

WTR, side view package, 2300 pcs

D. Bugeye: quantity per reel:

TT, 2500 pcs TR, 2500 pcs

- E. AP5: quantity per reel:
 - TT, 2500 pcs
 - TR, not available in side view
- F. Belobog: quantity per reel:
 - TT1, 1800 pcs
 - TT2, 7000 pcs
 - TR, not available in side view
- G. Belobog with shield: quantity per reel:
 - TT1, 1500 pcs

TT2, 5000 pcs

ORDER DESIGNATION

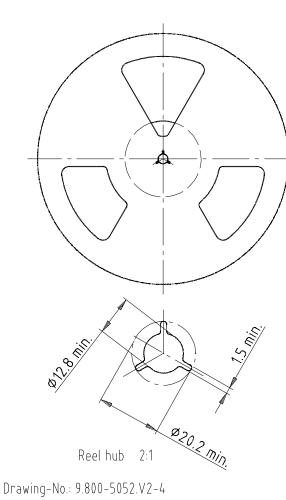
The type designation of the device is extended by TT or TT1 for top view or TR for side view.

Example:

- TSOP6238TR (reel packing) TSOP75238TR (reel packing) TSOP75338WTT (reel packing) TSOP85438TT (reel packing)
- TSOP85238AP5TR (reel packing)
- TSOP57438TT1 (reel packing)
- TSOP57238HTT1 (reel packing)



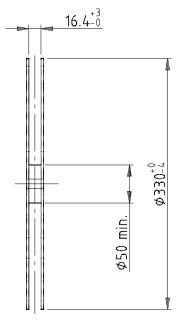
REEL DIMENSIONS FOR PANHEAD SMD AND HEIMDALL in millimeters



Drawing-No.: 9.800-5052.V Issue: 1; 07.05.02 16734

Note

• The body structure of the reel can vary



Form of the leave open of the wheel is supplier specific.

Dimension acc. to IEC EN 60 286-3

Tape width 16



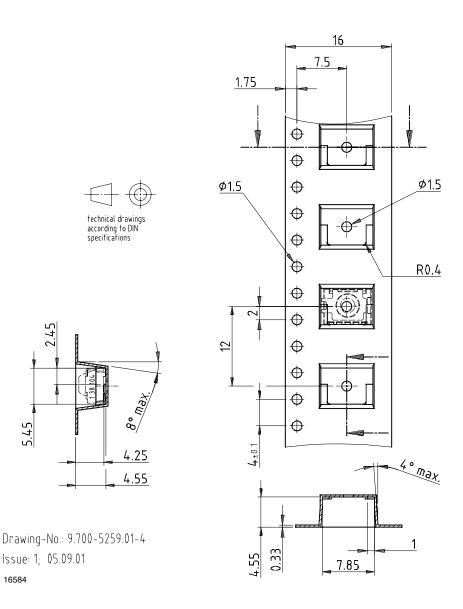
technical drawings according to DIN specifications

Rev. 2.1, 03-Dec-13



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

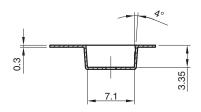
A. Panhead SMD (TSOP36...TT, TSOP35...TT, TSOP6...TT)

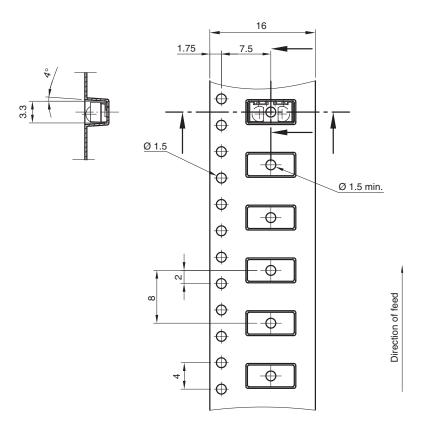




TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75...TT, TSOP77...TT)







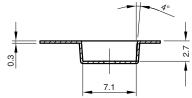
technical drawings according to DIN specifications

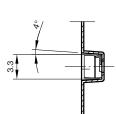
Drawing-No.: 9.700-5338.01-4 Issue: 3; 09.06.09 ²¹⁵⁷⁸

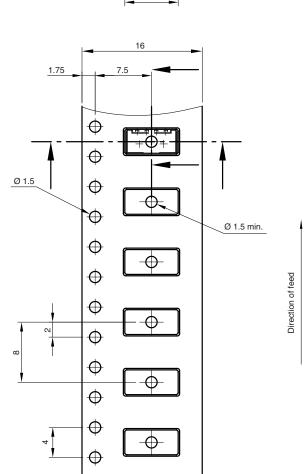


TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTT, TSOP77...WTT)









according to DIN specifications

Drawing-No.: 9.700-5341.01-4 Issue: 2: 23.03.09 21666

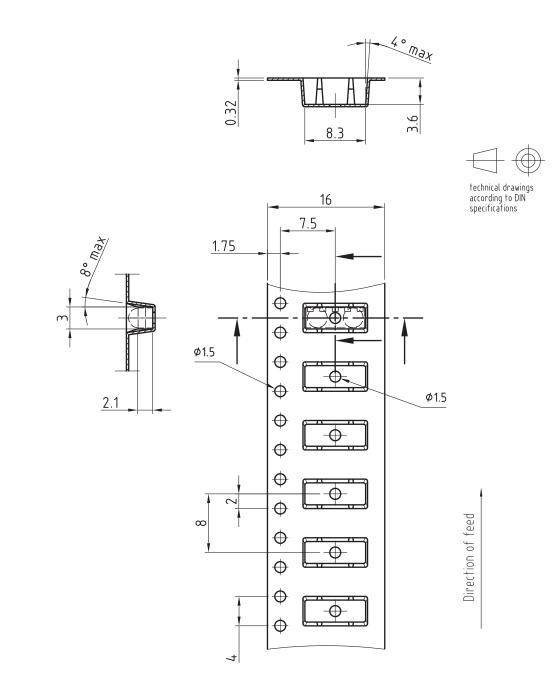


TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TT)

www.vishay.com

VISHAY



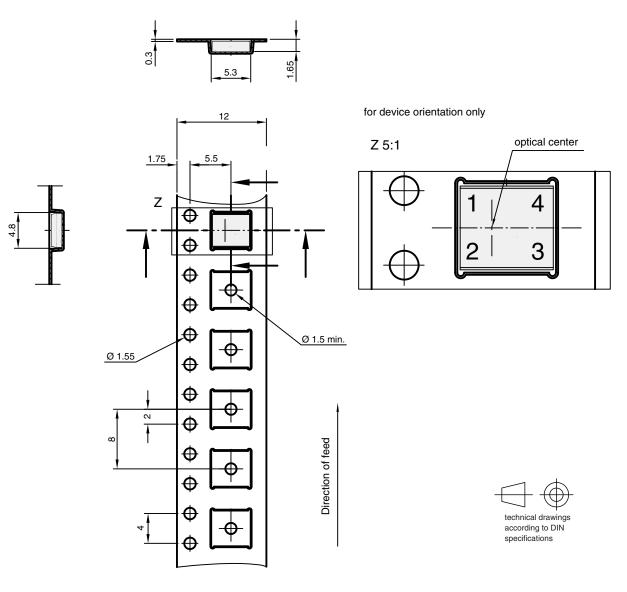
Drawing-No.: 9.700-5317.01-4 Issue: 2; 10.04.08 20629

Rev. 2.1, 03-Dec-13



TAPING VERSION TSOP..TT (TOP VIEW) DIMENSIONS in millimeters

E. AP5 (TSOP85...AP5TT)

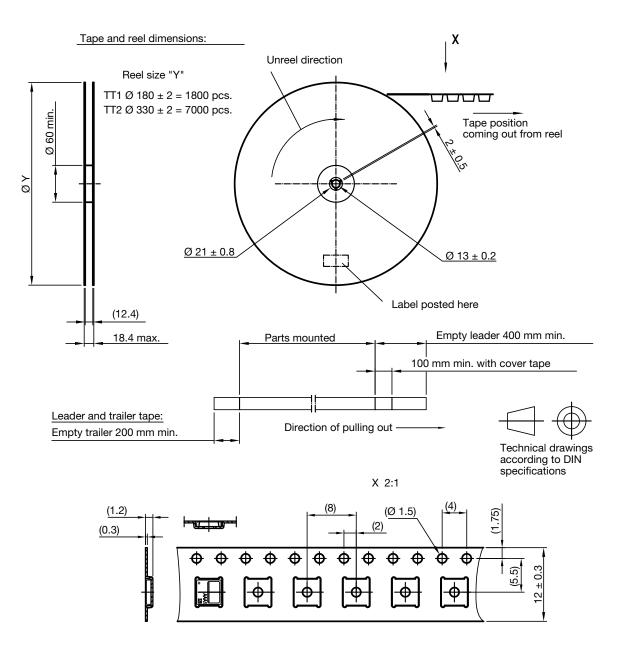


Drawing-No.: 9.700-5346.01-4 Issue: 2, 24.11.09 ²¹⁹⁴⁵



TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

F. Belobog (TSOP37...TT1, TSOP37...TT2, TSOP57...TT1, TSOP57...TT2)



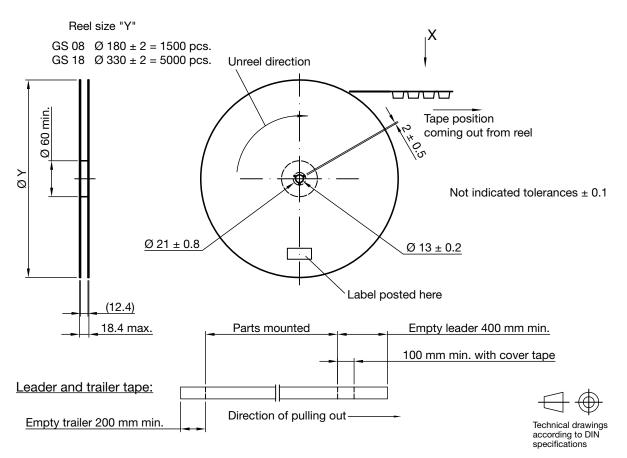
Drawing-No.: 9.700-5347.01-4 Issue: 1; 14.11.11 Not indicated tolerances ± 0.1



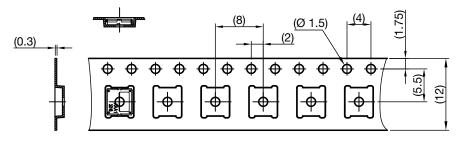
TAPING VERSION TSOP..TT1, TSOP..TT2 (TOP VIEW) DIMENSIONS in millimeters

G. Belobog with shield (TSOP37...HTT1, TSOP37...HTT2, TSOP57...HTT1, TSOP57...HTT2)

Tape and Reel dimensions:



X 2:1



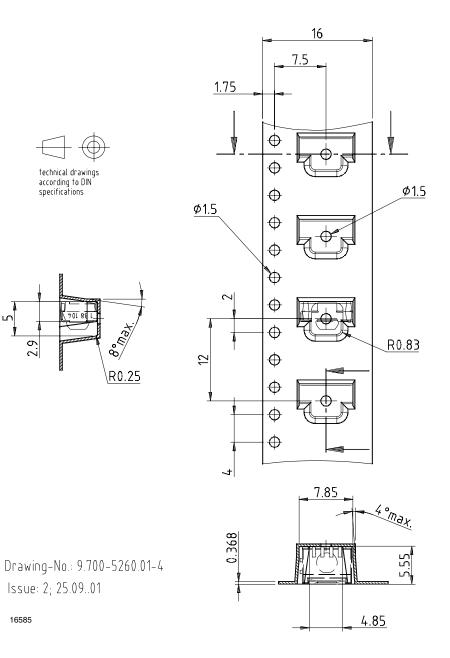
Reel dimensions and tape

Drawing-No.: 9.700-5380.01-4 Issue: 1; 28.10.13



TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

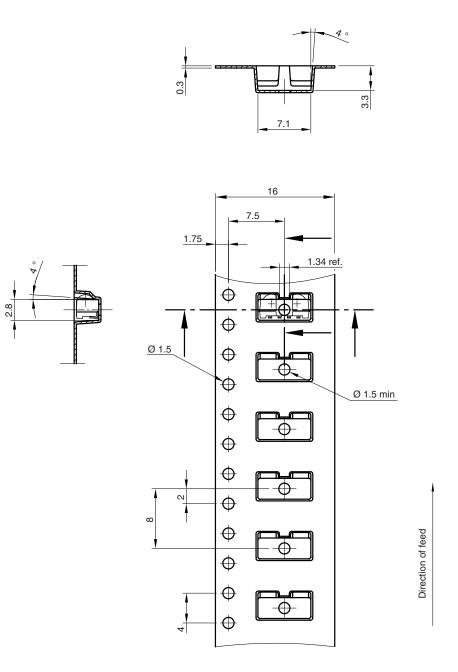
A. Panhead SMD (TSOP36...TR, TSOP35...TR, TSOP6...TR)





TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

B. Heimdall SMD (TSOP75..., TSOP77...)





technical drawings according to DIN specifications

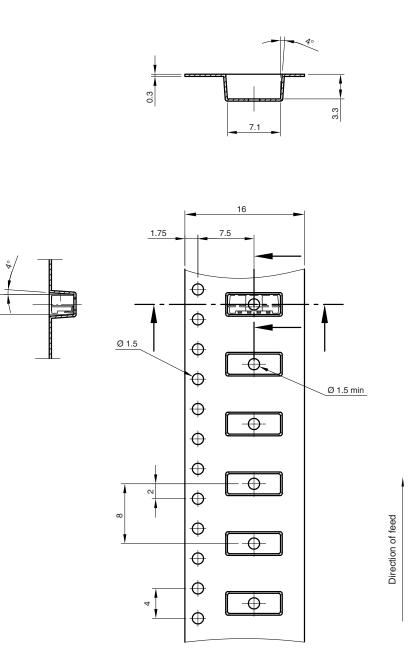
Drawing-No.: 9.700-5337.01-4 Issue: 1; 16.10.08 21577



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TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

C. Heimdall SMD without lens (TSOP75...WTR, TSOP77...WTR)



Drawing-No.: 9.700-5342.01-4 Issue: 1: 23.03.09 21785



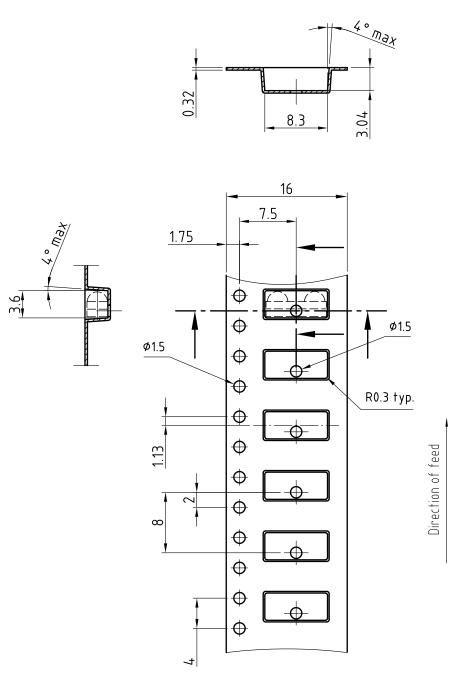
technical drawings according to DIN specifications

TAPING VERSION TSOP..TR (SIDE VIEW) DIMENSIONS in millimeters

D. Bugeye (TSOP85...TR)

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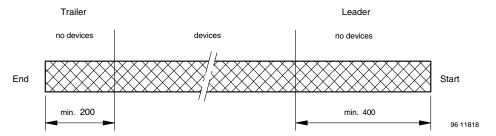
technical drawings according to DIN specifications

Drawing-No.: 9.700-5316.01-4 Issue: 1; 12.02.07 20628





LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE REEL STRENGTH

According to DIN EN 60286-3 0.1 N to 1.3 N 300 mm/min. \pm 10 mm/min. 165° to 180° peel angle

LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

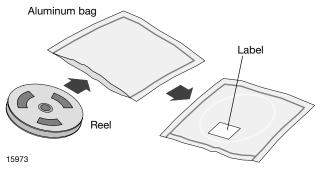
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	XXXXXXX+	Company logo
LONG BAR CODE TOP	ТҮРЕ	LENGTH
Item-number	Ν	8
Plant-code	Ν	2
Sequence-number	Х	3
Quantity	Ν	8
Total length	-	21
SHORT BAR CODE TOP	ТҮРЕ	LENGTH
Selection-code	Х	3
Data-code	Ν	3
Batch-number	Х	10
Filter	-	1
Total length	-	17

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DRY PACKAGING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity \leq 60 % RH max.

After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 $^{\circ}\text{C}$ + 5 $^{\circ}\text{C}$ / - 0 $^{\circ}\text{C}$ and < 5 % RH (dry air/nitrogen) or

96 h at 60 $^\circ\text{C}$ + 5 $^\circ\text{C}$ and < 5 % RH for all device containers or

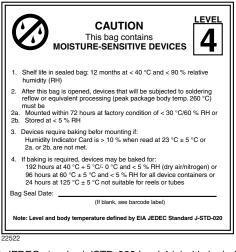
24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC[®] standard JSTD-020 level 4 label is included on all dry bags.

OUTER PACKAGING

The sealed reel is packed into a pizza box.

Vishay Semiconductors



EIA JEDEC standard JSTD-020 level 4 label is included on all dry bags

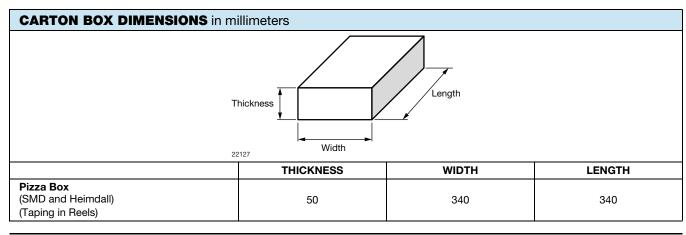
ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.





Rev. 2.1, 03-Dec-13

Document Number: 80125



Vishay

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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.